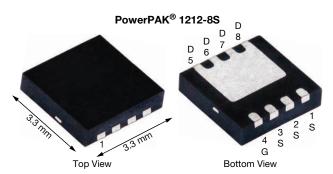


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Vishay Siliconix

## P-Channel 20 V (D-S) MOSFET



PRODUCT SUMMARY						
V <sub>DS</sub> (V)	-20					
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = -10 \text{ V}$	0.0040					
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = -4.5 \text{ V}$	0.0055					
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = -2.5 \text{ V}$	0.0095					
Q <sub>g</sub> typ. (nC)	55.5					
I <sub>D</sub> (A)	-35 <sup>a</sup>					
Configuration	Single					

#### **FEATURES**

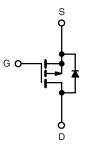
- TrenchFET® Gen III P-channel power MOSFET
- Thin 0.8 mm maximum height
- 100 % Rq and UIS tested
- Material categorization: for definitions of compliance please see www.vishav.com/doc?99912



ROHS COMPLIANT HALOGEN FREE

#### **APPLICATIONS**

- Smart phones, tablet PCs, and mobile computing
  - Battery switch
  - Load switch
  - Power management



P-Channel MOSFET

ORDERING INFORMATION	
Package	PowerPAK 1212-8S
Lead (Pb)-free and halogen-free	SiS415DNT-T1-GE3

ABSOLUTE MAXIMUM RATINGS (TA	= 25 °C, unles	ss otherwise not	ted)		
PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-source voltage		V <sub>DS</sub>	-20	V	
Gate-source voltage	Gate-source voltage		± 12	V	
	T <sub>C</sub> = 25 °C		-35 <sup>a</sup>		
Continuous drain current (T <sub>J</sub> = 150 °C)	T <sub>C</sub> = 70 °C	l-	-35 <sup>a</sup>		
	T <sub>A</sub> = 25 °C	l <sub>D</sub>	-22.6 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C		-18.2 <sup>b, c</sup>	٨	
Pulsed drain current (t = 300 μs)		I <sub>DM</sub>	-80	Α	
Continuous source-drain diode current	T <sub>C</sub> = 25 °C		-35 <sup>a</sup>		
Continuous source-drain diode current	T <sub>A</sub> = 25 °C	l <sub>s</sub> –	-3.3 <sup>b, c</sup>		
Avalanche current	L = 0.1 mH	I <sub>AS</sub>	-20		
Single pulse avalanche energy	L = 0.1 IIII1	E <sub>AS</sub>	20	mJ	
	$T_C = 25  ^{\circ}C$		52		
Maximum power dissipation	T <sub>C</sub> = 70 °C	В	33	Ω	
waximum power dissipation	T <sub>A</sub> = 25 °C	P <sub>D</sub>	3.7 <sup>b, c</sup>	52	
	T <sub>A</sub> = 70 °C		2.4 <sup>b, c</sup>		
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C	
Soldering recommendations (peak temperature) d,	Soldering recommendations (peak temperature) d, e		260		

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT
Maximum junction-to-ambient b, f	t ≤ 10 s	$R_{thJA}$	26	33	°C/W
Maximum junction-to-case (drain)	Steady state	$R_{thJC}$	1.9	2.4	C/W

#### Notes

- a. Package limited
- b. Surface mounted on 1" x 1" FR4 board
- c. t = 10 s
- d. See solder profile (<u>www.vishay.com/doc?73257</u>). The PowerPAK 1212-8S is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection
- e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components
- f. Maximum under steady state conditions is 81 °C/W



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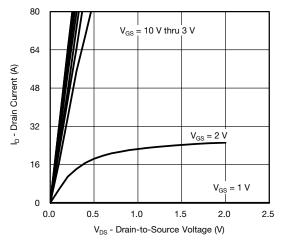
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static						L
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	-20	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$		-	-14	-	1460
V <sub>GS(th)</sub> temperature coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = -250 μA	-	3.1	-	mV/°C
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = -250 \mu A$	-0.4	-	-1.5	V
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 12 \text{ V}$	-	-	± 100	nA
7		$V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}$	-	-	-1	μΑ
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = -20 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C	-	-	-10	
On-state drain current a	I <sub>D(on)</sub>	$V_{DS} \le -5 \text{ V}, V_{GS} = -10 \text{ V}$	-30	-	-	Α
	, ,	V <sub>GS</sub> = -10 V, I <sub>D</sub> = -20 A	-	0.0033	0.0040	
Drain-source on-state resistance a	R <sub>DS(on)</sub>	$V_{GS} = -4.5 \text{ V}, I_D = -15 \text{ A}$	-	0.0044	0.0055	Ω
	, ,	$V_{GS} = -2.5 \text{ V}, I_D = -10 \text{ A}$	-	0.0076	0.0095	
Forward transconductance a	9 <sub>fs</sub>	$V_{DS} = -10 \text{ V}, I_D = -20 \text{ A}$	-	70	-	S
Dynamic <sup>b</sup>						
Input capacitance	C <sub>iss</sub>		-	5460	-	
Output capacitance	Coss	$V_{DS} = -10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	645	-	pF
Reverse transfer capacitance	C <sub>rss</sub>		-	642	-	
Tatal auto abanno		$V_{DS} = -10 \text{ V}, V_{GS} = -10 \text{ V}, I_D = -10 \text{ A}$	-	117	180	nC
Total gate charge	$Q_g$		-	55.5	85	
Gate-source charge	$Q_{gs}$	$V_{DS} = -10 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -10 \text{ A}$	-	7.9	-	
Gate-drain charge	$Q_{gd}$		-	12.7	-	
Gate resistance	Rg	f = 1 MHz	0.4	2.2	4	Ω
Turn-on delay time	t <sub>d(on)</sub>		-	37	70	
Rise time	t <sub>r</sub>	$V_{DD}$ = -10 V, $R_L$ = 1 $\Omega$	-	38	70	
Turn-off delay time	t <sub>d(off)</sub>	$I_D \cong -10 \text{ A}, V_{GEN} = -4.5 \text{ V}, R_g = 1 \Omega$	-	82	150	
Fall time	t <sub>f</sub>		-	25	50	
Turn-on delay time	t <sub>d(on)</sub>		-	14	25	ns
Rise time	t <sub>r</sub>	$V_{DD}$ = -10 V, $R_L$ = 1 $\Omega$	-	13	25	-
Turn-off delay time	t <sub>d(off)</sub>	$I_D \cong -10 \text{ Å}, V_{GEN} = -10 \text{ V}, R_g = 1 \Omega$	-	83	150	
Fall time	t <sub>f</sub>		-	14	25	
<b>Drain-Source Body Diode Characterist</b>	ics					
Continuous source-drain diode current	I <sub>S</sub>	T <sub>C</sub> = 25 °C	-	-	-35	^
Pulse diode forward current	I <sub>SM</sub>		-	-	-80	Α
Body diode voltage	V <sub>SD</sub>	$I_{S} = -4 \text{ A}, V_{GS} = 0 \text{ V}$	-	-0.72	-1.1	V
Body diode reverse recovery time	t <sub>rr</sub>		-	25	50	ns
Body diode reverse recovery charge	Q <sub>rr</sub>	10 A di/d+ 100 A/ T 05 00	-	12	24	nC
Reverse recovery fall time	ta	$I_F = -10 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$	-	11	-	
Reverse recovery rise time	t <sub>b</sub>		_	14	_	ns

#### Notes

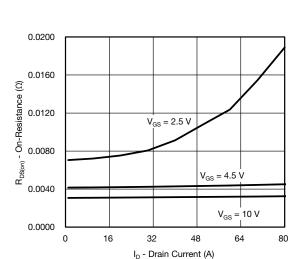
- a. Pulse test: pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2 %
- b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

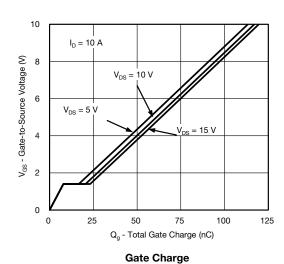


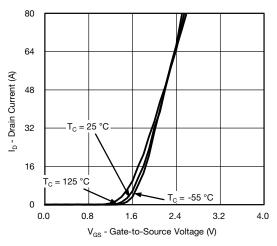


#### **Output Characteristics**

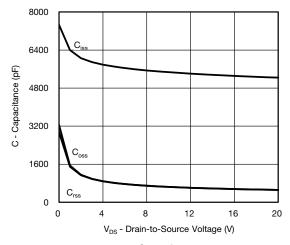


On-Resistance vs. Drain Current and Gate Voltage

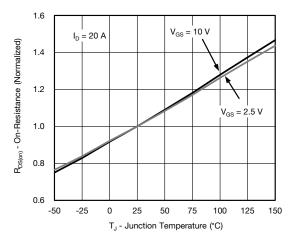




**Transfer Characteristics** 

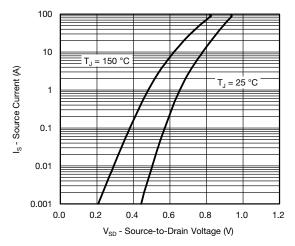


Capacitance

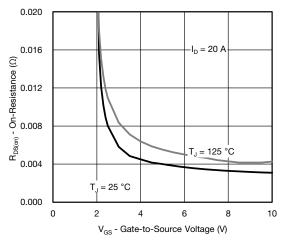


On-Resistance vs. Junction Temperature

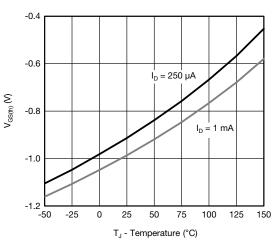




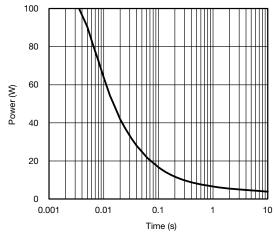
Source-Drain Diode Forward Voltage



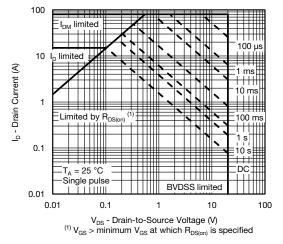
On-Resistance vs. Gate-to-Source Voltage



**Threshold Voltage** 

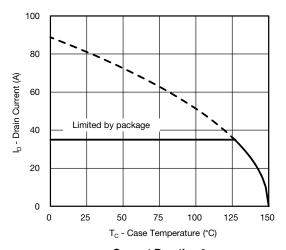


Single Pulse Power, Junction-to-Ambient

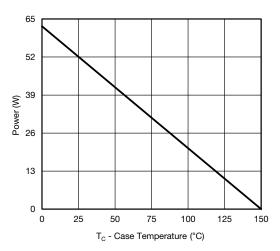


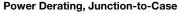
Safe Operating Area, Junction-to-Ambient

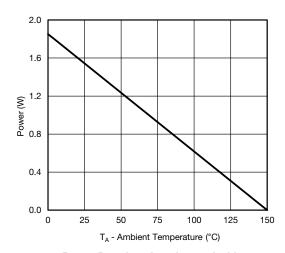




#### Current Derating a





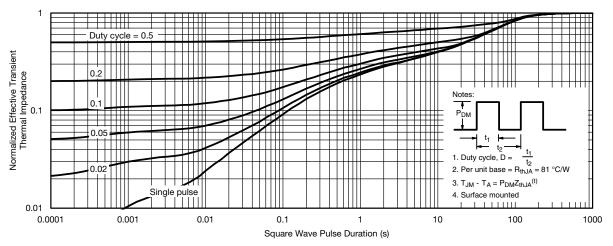


Power Derating, Junction-to-Ambient

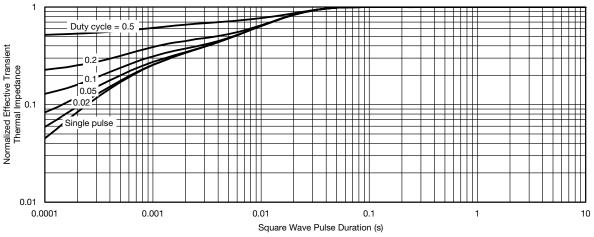
### Note

a. The power dissipation P<sub>D</sub> is based on T<sub>J</sub> max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





Normalized Thermal Transient Impedance, Junction-to-Ambient



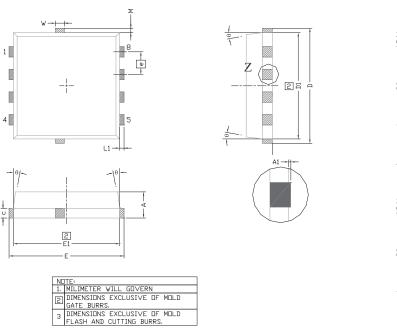
Normalized Thermal Transient Impedance, Junction-to-Case

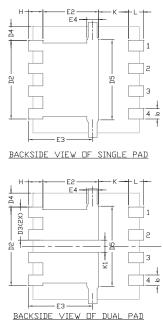
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## PowerPAK® 1212-8T





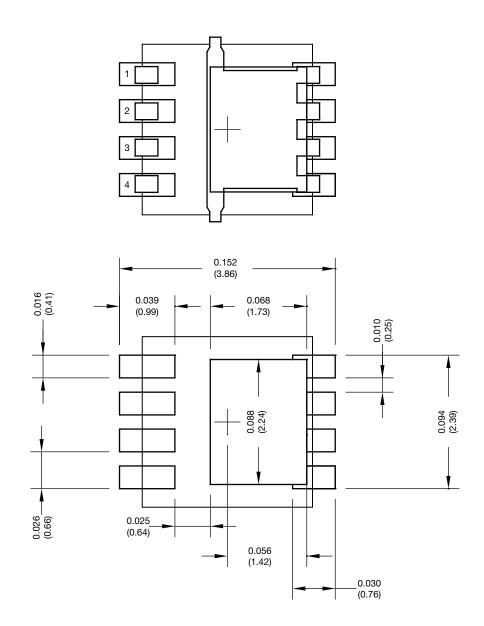
	MILLIMETERS			INCHES			
DIM.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
А	0.70	0.75	0.80	0.028	0.030	0.031	
A1	0.00	-	0.05	0.000	-	0.002	
b	0.23	0.30	0.41	0.009	0.012	0.016	
С	0.23	0.28	0.33	0.009	0.011	0.013	
D	3.20	3.30	3.40	0.126	0.130	0.134	
D1	2.95	3.05	3.15	0.116	0.120	0.124	
D2	1.98	2.11	2.24	0.078	0.083	0.088	
D3	0.48	-	0.89	0.019	-	0.035	
D4	0.47 TYP.			0.0185 TYP.			
D5		2.3 TYP.		0.090 TYP.			
Е	3.20	3.30	3.40	0.126	0.130	0.134	
E1	2.95	3.05	3.15	0.116	0.120	0.124	
E2	1.47	1.60	1.73	0.058	0.063	0.068	
E3	1.75	1.85	1.98	0.069	0.073	0.078	
E4		0.34 TYP.		0.013 TYP.			
е		0.65 BSC		0.026 BSC			
K		0.86 TYP.			0.034 TYP.		
K1	0.35	-	-	0.014	-	-	
Н	0.30	0.41	0.51	0.012	0.016	0.020	
L	0.30	0.43	0.56	0.012	0.017	0.022	
L1	0.06	0.13	0.20	0.002	0.005	0.008	
θ	0°	-	12°	0°	-	12°	
W	0.15	0.25	0.36	0.006	0.010	0.014	
М		0.125 TYP. 0.005 TYP.					

DWG: 6012

Revison: 18-Feb-13 Document Number: 62836



# Recommended Minimum PADs for Thin PowerPAK® 1212-8T





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